

HAO WANG

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Division of Production Systems, Department of Industrial and Materials Science
Chalmers University of Technology

EDUCATION

Chalmers University of Technology <i>Ph.D. candidate in Product and Production Development</i>	2021 - Present Gothenburg, Sweden
The University of Edinburgh <i>MSc with Distinction in Informatics</i>	2018 - 2019 Edinburgh, UK
University of Skövde <i>Exchange Student in Informatics</i>	Sept. 2016 - Jan. 2017 Skövde, Sweden
Beijing University of Posts and Telecommunications <i>B.Eng. in Telecommunication Engineering</i>	2014 - 2018 Beijing, China

PUBLICATION

Journal

3. Johansson, B., Despeisse, D., Bokrantz, J., Braun, G., Cao, H., Chari, A., Fang, Q., González Chávez, C. A., Skoogh, A., Söderlund, H., Wang, H., Wärnefjord, K., Nyborg, L., Sun, J., Örtengren, R., Schumacher, K. A., Espinal, L., Morris, K. C., Nunley, J., Kishita, Y., Umeda, Y., Acerbi, F., Pinzone, M., Persson, H., Charpentier, S., Edström, K., Brandell, D., Gopalakrishnan, M., Rahnama, H., Abrahamsson, L., Rönnbäck, A. Ö., & Stahre, J. (2024). Challenges and Opportunities to Advance Manufacturing Research for Sustainable Battery Life Cycles. *Frontiers in Manufacturing Technology*, 4, 1360076. doi:10.3389/fmtec.2024.1360076
2. Wang, H., Salunkhe, O., Quadrini, W., Lämkuil, D., Ore, F., Despeisse, M., Fumagalli, L., Stahre, J., & Johansson, B. (2024). A systematic literature review of computer vision applications in robotized wire harness assembly. *Advanced Engineering Informatics*, 62, 102596. doi:10.1016/j.aei.2024.102596
1. Zhu, X., Yu, C., Huang, D., Lei, Z., Wang, H., & Li, S. Z. (2023). Beyond 3dmm: Learning to capture high-fidelity 3d face shape. *IEEE Transactions on Pattern Analysis and Machine Intelligence*, 45(2), 1442-1457. doi:10.1109/TPAMI.2022.3164131

Conference

6. Wang, H., Salunkhe, O., Quadrini, W., Lämkuil, D., Ore, F., Johansson, B., & Stahre, J. (2023). Overview of computer vision techniques in robotized wire harness assembly: Current state and future opportunities. *Procedia CIRP*, 120, 1071-1076. doi:10.1016/j.procir.2023.09.127
5. Salunkhe, O., Quadrini, W., Wang, H., Stahre, J., Romero, D., Fumagalli, L., & Lämkuil, D. (2023). Review of current status and future directions for collaborative and semi-automated automotive wire harnesses assembly. *Procedia CIRP*, 120, 696-701. doi:10.1016/j.procir.2023.09.061
4. Wang, H., & Johansson, B. (2023). Deep learning-based connector detection for robotized assembly of automotive wire harnesses. *2023 IEEE 19th International Conference on Automation Science and Engineering (CASE)*, 1-8. doi:10.1109/CASE56687.2023.10260619
3. Despeisse, M., Johansson, B., Bokrantz, J., Braun, G., Chari, A., Chen, X., Fang, Q., González Chávez, C. A., Skoogh, A., Stahre, J., Theradapuzha Mathew, N., Turanoglu Bekar, E., Wang, H., & Örtengren, R. (2023). Battery production systems: State of the art and future developments. *Advances in Production Management Systems. Production Management Systems for Responsible Manufacturing, Service, and Logistics Futures*, 521-535. doi:10.1007/978-3-031-43688-8_36
2. Zhu, X., Wang, H., Fei, H., Lei, Z., & Li, S. Z. (2021). Face forgery detection by 3d decomposition. *2021 IEEE/CVF Conference on Computer Vision and Pattern Recognition (CVPR)*, 2928-2938. doi:10.1109/CVPR46437.2021.00295
1. Zhu, X., Yang, F., Huang, D., Yu, C., Wang, H., Guo, J., Lei, Z., & Li, S. Z. (2020). Beyond 3dmm space: Towards fine-grained 3d face reconstruction. *Computer Vision - ECCV 2020*, 343-358. doi:10.1007/978-3-030-58598-3_21

Report

2. 2024 World Manufacturing Report-New Perspectives for the Future of Manufacturing: Outlook 2030
1. 2023 World Manufacturing Report-New Business Models for the Manufacturing of the Future

Thesis

1. Wang, H. (2024). *Toward enabling robotic visual perception for assembly tasks*[Licentiate thesis]

RESEARCH PROJECTS

Empowering Human Workers for Assembly of Wire Harnesses (EWASS) 2022-2025
SIP Produktion2030, VINNOVA

- To assist the industry in ensuring a sustainable work-life by empowering human workers during assembly of wire harnesses
- To improve productivity, quality, and ergonomics of assembly installation of wire harnesses and high voltage cables using collaborative robots, thereby boosting the manufacturing of electrified vehicles

PLENary multi-User developMent arena for future industrial workspaces (PLENUM) 2022-2025
VINNOVA

- To provide industry with methods and design tools to create sustainable factories/workplaces/manual operations in a multi-user development environment
- To develop and demonstrate an easy-to-use (low threshold) cost-effective interactive multi-user 3D environment for development, workplace design, upskilling and ergonomic analysis that includes thousands of users and reduces environmental impact

Boosting the Exploitation of Standardisation Inputs from European Projects (STAND4EU) 2022-2024
EU

- To strengthen the links between research, innovation and standardisations ensuring that standardisation is an integral part of the European research and innovation landscape

DIGITAL work InStructions for cognitive work (DIGITALIS) 2022-2024
SIP Produktion2030, VINNOVA

- To demonstrate how systematic development of cognitive support and information design can increase quality and flexibility in future production

A Pan-European Network of Robotics DIHs for Agile Production (DIH²) 2019-2023
EU

- To spark incremental and disruptive innovations in over 300,000 Manufacturing SMEs and Mid-Caps
- [Project webpage](#)

OTHER PROJECTS

Gender Identification from 3D Facial Surface Model Feb. 2019 - Aug. 2019
Dissertation for Master's degree

- Proposed a novel method on 3D facial gender identification with machine learning & conformal mapping
- Evaluated the proposed method and obtained competitive performance (accuracy over 88%)

Action Recognition Model with First-Person Videos Jan. 2019 - Mar. 2019

- Evaluated third-person action recognition methods with first-person datasets
- Compared the differences between the third and first-person methods
- Proposed and studied a new model combining MobileNet and Two-stream Pyramid

Image Super-Resolution with Convolutional Neural Network Dec. 2017 - June 2018
Dissertation for Bachelor's degree

- Realized the subpixel-based image super-resolution method with pixel shuffle
- Tested the model on both image and video datasets

RESEARCH EXPERIENCE

National Laboratory of Pattern Recognition, CASIA

Oct. 2019 - June 2021

Research Intern

Beijing, China

- Projects: Fine-grained 3D face reconstruction; Face forgery detection; Face anti-spoofing

Next Generation Internet Research Center, BUPT

May 2017 - Oct. 2017

Undergraduate Research Assistant

Beijing, China

- Projects: Optimization on DASH-based video service in high-speed railway networks with stochastic methods; Network flow variation detection with mobile crowd sensing

TEACHING EXPERIENCE

MPR213 Robotics and Manufacturing Automation

Chalmers

- Apr. - May 2024: Lecturer (Robotics, AI, and computer vision)

LMT108 Automation Technique

Chalmers

- Jan. - Mar. 2024: Lecturer (Robotics, AI, and computer vision)

IMS020 Simulation and Visualisation of Production Systems

Chalmers

- Sept. - Oct. 2021: Lab assistant
- Sept. - Oct. 2022: Course coordinator, lecturer, and lab assistant; Course evaluation: 4.2/5.0
- Sept. - Oct. 2023: Course coordinator, lecturer, and lab assistant; Course evaluation: 3.75/5.0
- Sept. - Oct. 2024: Course coordinator, lecturer, and lab assistant

PPU055 Virtual production

Chalmers

- Oct. - Dec. 2021: Lecturer and lab assistant
- Oct. - Dec. 2022: Lecturer and lab assistant
- Oct. - Dec. 2023: Lab assistant

IMS085 Simulation and optimization of sustainable production systems

Chalmers

- Jan. - May 2022: Lab assistant
- Jan. - May 2023: Lab assistant
- Jan. - May 2024: Lab assistant

PPU161 Production systems

Chalmers

- Oct. - Dec. 2022: Project tutor

PPU215 Research methodology in production projects

Chalmers

- Jan. - Mar. 2022: Project tutor

PPU156 Computer Aided Design (CAD)

Chalmers

- Oct. - Dec. 2021: Lecturer

ACADEMIC SERVICE

Reviewer

- IEEE International Conference on Multimedia and Expo

SKILLS

Programming Languages: Python, MATLAB, C, C++, Java, Go, VHDL, Verilog, Assembly Language

Tools: PyTorch, Tensorflow, OpenCV, Dlib, Plant Simulation, Visual Components, RobotStudio

Others: Linux, Git, SQL, L^AT_EX, FPGA, Arduino, Raspberry Pi, NVIDIA Jetson Nano, PolyScope